

# **Features**

- Halogen Free. "Green" Device (Note 1)
- · High Current Capability
- Low Profile Package
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

# 1 Amp Gi fZJWY A ci bh GW chh\_mF YWJZJYf 50 to 200 Volts

# Maximum Ratings @ 25°C (Unless Otherwise Specified)

	Symbol	Value						
Parameter		SMD 15PL	SMD 16PL	SMD 18PL	SMD 110PL	SMD 1150PL	SMD 1200PL	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$							
Working Peak Reverse Voltage	$V_{RWM}$	50	50 60	80	100	150	200	V
DC Blocking Voltage	$V_R$							
RMS Reverse Voltage	V <sub>RMS</sub>	35	42	56	70	105	140	V
Average Rectified Forward Current	I <sub>F(AV)</sub>	1				Α		
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	I <sub>FSM</sub>	30			А			
Current Squared Time @1ms≤t≤8.3ms	I <sup>2</sup> t	3.735			A <sup>2</sup> s			

# Marking code

Part Number	Marking Code
SMD15PL	D5
SMD16PL	D6
SMD18PL	D8
SMD110PL	D10
SMD1150PL	D15
SMD1200PL	D20

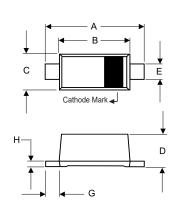
# **Internal Structure**

Pin	Description	Simplified Outline	Graphic Symbol
1	Cathode	1 XXX 2	
2	Anode	XXX = Marking code	1 0

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

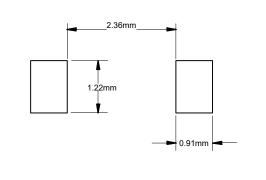
2. High temperature solder exemption applied, see EU directive annex 7a.

# SOD-123FL



DIMENSIONS						
DIM INCI		HES	MM		NOTE	
ווועו	MIN	MAX	MIN	MAX	NOTE	
Α	0.130	0.152	3.30	3.85		
В	0.100	0.122	2.55	3.10		
С	0.055	0.075	1.40	1.90		
D	0.035	0.053	0.90	1.35		
Е	0.020	0.041	0.50	1.05		
G	0.010		0.25			
Н		0.010		0.25		

### SUGGESTED SOLDER PAD LAYOUT





# Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_J$	Operating Junction Temperature Range		-55		150	°C
T <sub>stg</sub>	Storage Temperature Range		-55		150	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		25		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		88		°C/W

#### Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified

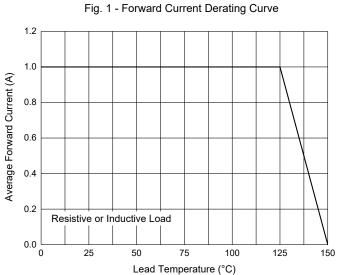
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage						
SMD15PL~SMD16PL	V <sub>F</sub>	I <sub>F</sub> =1A;T <sub>J</sub> =25°C			0.70	V
SMD18PL~SMD1150PL					0.85	
SMD1200PL					0.95	
Reverse Current						
SMD15PL~SMD16PL	I <sub>R</sub>	at Rated V <sub>R</sub> ;T <sub>J</sub> =25°C			0.1	mA
		at Rated V <sub>R</sub> ;T <sub>J</sub> =125°C			20	
SMD18PL~SMD1200PL		at Rated V <sub>R</sub> ;T <sub>J</sub> =25°C			0.01	
		at Rated V <sub>R</sub> ;T <sub>J</sub> =125°C			5	
Junction Capacitance						
SMD15PL~SMD16PL	CJ	$V_R=4V;f=1MHz;T_J=25$ °C		40		pF
SMD18PL~SMD110PL				30		
SMD1150PL~SMD1200PL				20		

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<sup>1.</sup>Mounted on P.C.B. with 5mm\*5mm copper pad areas.



# **Curve Characteristics**

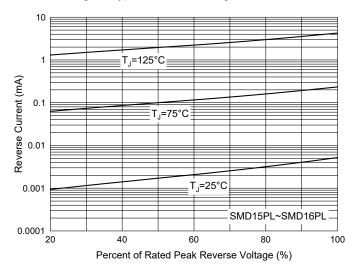


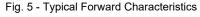
Lead Temperature (°C)

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current 35 30 Peak Forward Surge Current (A) 25 20 15 10 8.3 ms Single Half Sine-Wave 0 100 Number of Cycles at 60 Hz

Fig. 3 - Typical Forward Characteristics Forward Current (A) T<sub>1</sub>=25°C =75°C =125°C SMD15PL~SMD16PL 0.01 - 0.0 0.2 0.4 0.8 1.0 Forward Voltage (V)

Fig. 4 - Typical Reverse Leakage Characteristics





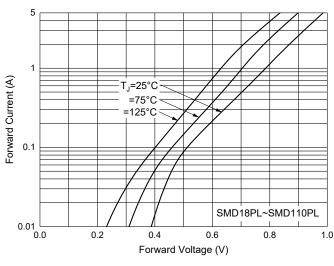
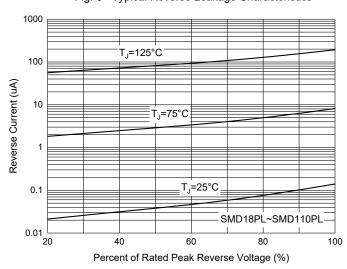


Fig. 6 - Typical Reverse Leakage Characteristics





# **Curve Characteristics**

Fig. 7 - Typical Forward Characteristics

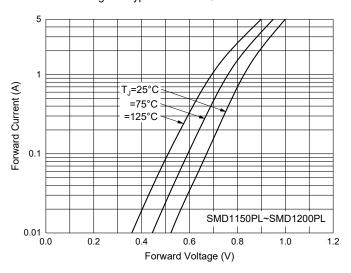


Fig. 9 - Typical Capacitance Characteristics

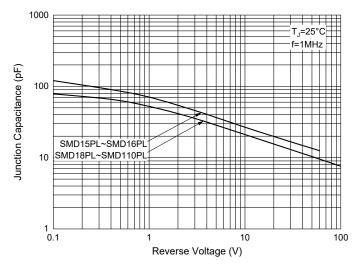


Fig. 8 - Typical Reverse Leakage Characteristics

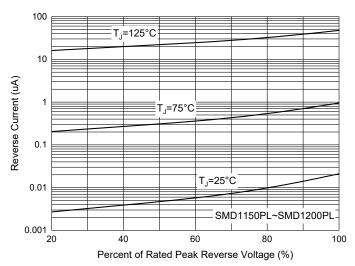
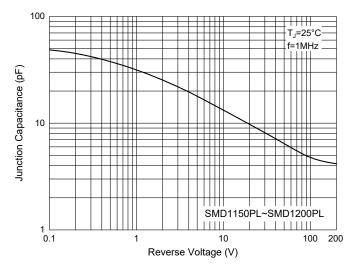


Fig. 10 - Typical Capacitance Characteristics





# **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel:2.5Kpcs/Reel

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